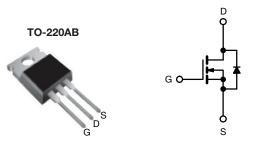


# **D Series Power MOSFET**



N-Channel MOSFET

PRODUCT SUMMARY					
V <sub>DS</sub> (V) at T <sub>J</sub> max.	550				
R <sub>DS(on)</sub> max. (Ω) at 25 °C	V <sub>GS</sub> = 10 V	1.5			
Q <sub>g</sub> max. (nC)	20				
Q <sub>gs</sub> (nC)	3				
Q <sub>gd</sub> (nC)	5				
Configuration	Single				

#### **FEATURES**

- Optimal design
  - Low area specific on-resistance
  - Low input capacitance (Ciss)
  - Reduced capacitive switching losses
  - High body diode ruggedness
  - Avalanche energy rated (UIS)
- · Optimal efficiency and operation
  - Low cost
  - Simple gate drive circuitry
  - Low figure-of-merit (FOM): Ron x Qg
  - Fast switching
- Material categorization: for definitions of compliance please see <a href="https://www.vishay.com/doc?99912"><u>www.vishay.com/doc?99912</u></a>

#### **APPLICATIONS**

- Consumer electronics
  - Displays (LCD or plasma TV)
- · Server and telecom power supplies
  - SMPS
- Industrial
  - Welding
  - Induction heating
  - Motor drives
- · Battery chargers

ORDERING INFORMATION				
Package	TO-220AB			
Lead (Pb)-free	IRF830BPbF			
Lead (Pb)-free and halogen-free	IRF830BPbF-BE3			

PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-source voltage			V <sub>DS</sub>	500		
Gate-source Voltage				± 30	V	
Gate-source voltage AC (f > 1 Hz)			V <sub>GS</sub>	30		
Continuous drain current (T <sub>J</sub> = 150 °C)		V <sub>GS</sub> at 10 V	$T_{\rm C} = 25 ^{\circ}{\rm C}$ $T_{\rm C} = 100 ^{\circ}{\rm C}$		5.3	
	l v		T <sub>C</sub> = 100 °C	I <sub>D</sub>	3.4	Α
Pulsed drain current <sup>a</sup>			I <sub>DM</sub>	10		
Linear derating factor				0.83	W/°C	
Single pulse avalanche energy b			E <sub>AS</sub>	28.8	mJ	
Maximum power dissipation			P <sub>D</sub>	104	W	
Operating junction and storage temperature range			T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C	
Drain-source voltage slope		T <sub>J</sub> = 125 °C		dV/dt	24	\//no
Reverse diode dV/dt <sup>d</sup>	•			av/at	0.28	- V/ns
Soldering recommendations (peak temperatur	re) <sup>c</sup>	For 10 s			300	°C

## Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature
- b.  $V_{DD}$  = 50 V, starting  $T_J$  = 25 °C, L = 2.3 mH,  $R_q$  = 25  $\Omega$ ,  $I_{AS}$  = 5 A
- c. 1.6 mm from case
- d.  $I_{SD} \le I_D$ , starting  $T_J = 25~^{\circ}C$



# Vishay Siliconix

THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	TYP.	MAX.	UNIT	
Maximum junction-to-ambient	R <sub>thJA</sub>	-	62	°C/W	
Maximum junction-to-case (drain)	$R_{thJC}$	-	1.2	C/VV	

PARAMETER	SYMBOL	TES	MIN.	TYP.	MAX.	UNIT	
Static						•	
Drain-source breakdown voltage	V <sub>DS</sub>	V <sub>GS</sub> =	500	-	-	V	
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_{J}$	Reference	Reference to 25 °C, I <sub>D</sub> = 250 μA		0.58	-	V/°C
Gate-source threshold voltage (N)	V <sub>GS(th)</sub>	V <sub>DS</sub> =	· V <sub>GS</sub> , I <sub>D</sub> = 250 μA	3	-	5	V
Gate-source leakage	I <sub>GSS</sub>	,	$V_{GS} = \pm 30 \text{ V}$		-	± 100	nA
Zaus ante la litaria dunia comunit		V <sub>DS</sub> = 500 V, V <sub>GS</sub> = 0 V		-	-	1	
Zero gate boltage drain current	I <sub>DSS</sub>	$V_{DS} = 400 \text{ V}$	', V <sub>GS</sub> = 0 V, T <sub>J</sub> = 125 °C	-	-	10	μA
Drain-source on-state resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V	I <sub>D</sub> = 2.5 A	-	1.2	1.5	Ω
Forward transconductance a	9 <sub>fs</sub>	V <sub>DS</sub> :	= 20 V, I <sub>D</sub> = 2.5 A	-	1.8	-	S
Dynamic							
Input capacitance	C <sub>iss</sub>	$V_{GS} = 0 \text{ V},$ $V_{DS} = 100 \text{ V},$ $f = 1 \text{ MHz}$		-	325	-	pF
Output capacitance	C <sub>oss</sub>			-	34	-	
Reverse transfer capacitance	C <sub>rss</sub>			-	6	-	
Effective output capacitance, energy related <sup>b</sup>	$C_{o(er)}$	$V_{DS} = 0 \text{ V to } 400 \text{ V}, V_{GS} = 0 \text{ V}$		-	31	-	
Effective output capacitance, time related <sup>c</sup>	C <sub>o(tr)</sub>			-	41	-	
Total gate charge	Qg			-	10	20	
Gate-source charge	$Q_{gs}$	$V_{GS} = 10 \text{ V}$	$V_{GS} = 10 \text{ V}$ $I_D = 2.5 \text{ A}, V_{DS} = 400 \text{ V}$		3	-	nC
Gate-drain charge	Q <sub>gd</sub>			-	5	-	
Turn-on delay time	t <sub>d(on)</sub>	$V_{DD} = 400 \text{ V}, I_{D} = 2.5 \text{ A}$ $R_{g} = 9.1 \Omega, V_{GS} = 10 \text{ V}$		-	12	24	- ns
Rise time	t <sub>r</sub>			-	11	22	
Turn-off delay time	t <sub>d(off)</sub>			-	14	28	
Fall time	t <sub>f</sub>			-	11	22	
Gate input resistance	$R_g$	f = 1 MHz, open drain		0.8	1.7	3.4	Ω
<b>Drain-Source Body Diode Characteristic</b>	es						
Continuous source-drain diode current	I <sub>S</sub>	MOSFET symbol showing the integral reverse P - N junction diode		-	-	5	
Pulsed diode forward current	I <sub>SM</sub>			-	-	20	A
Diode forward voltage	V <sub>SD</sub>	T <sub>J</sub> = 25 °C, I <sub>S</sub> = 4 A, V <sub>GS</sub> = 0 V		-	-	1.2	V
Reverse recovery time	t <sub>rr</sub>	$T_J = 25 ^{\circ}\text{C}$ , $I_F = I_S = 2.5 \text{A}$ , $dI/dt = 100 \text{A/}\mu\text{s}$ , $V_R = 20 \text{V}$		-	320	-	ns
Reverse recovery charge	$Q_{rr}$			-	1.2	-	μC
Reverse recovery current	I <sub>RRM</sub>			-	8	-	Α

## Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature.
- b.  $C_{oss(er)}$  is a fixed capacitance that gives the same energy as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$ .
- c.  $C_{oss(tr)}$  is a fixed capacitance that gives the same charging time as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$ .



## TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

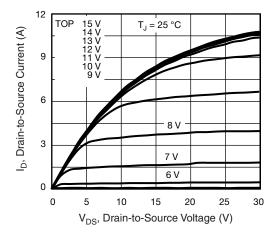


Fig. 1 - Typical Output Characteristics

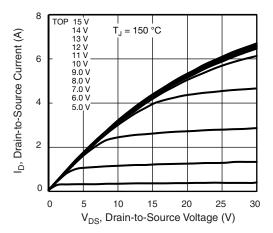


Fig. 2 - Typical Output Characteristics

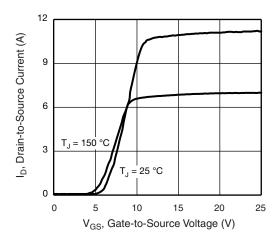


Fig. 3 - Typical Transfer Characteristics

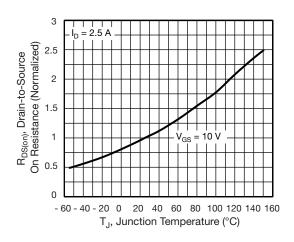


Fig. 4 - Normalized On-Resistance vs. Temperature

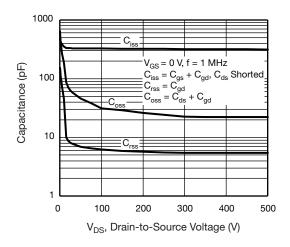


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

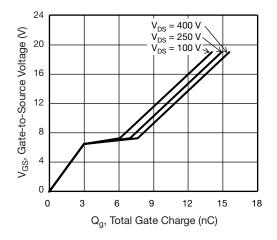


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage



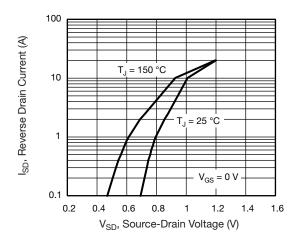


Fig. 7 - Typical Source-Drain Diode Forward Voltage

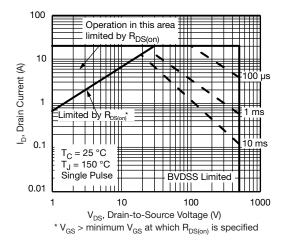


Fig. 8 - Maximum Safe Operating Area

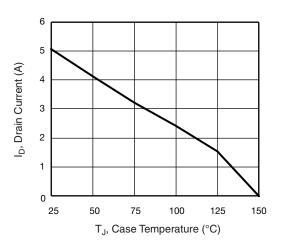


Fig. 9 - Maximum Drain Current vs. Case Temperature

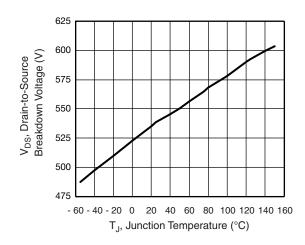


Fig. 10 - Typical Drain-to-Source Voltage vs. Temperature

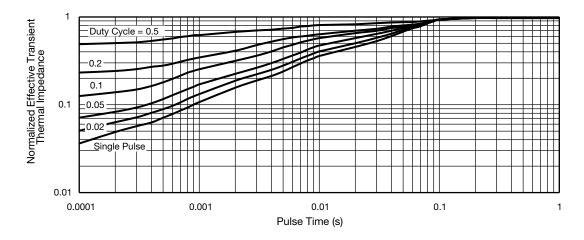


Fig. 11 - Normalized Thermal Transient Impedance, Junction-to-Case



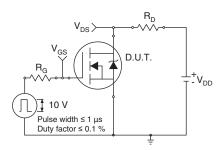


Fig. 12 - Switching Time Test Circuit

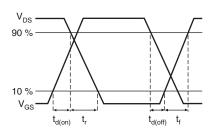


Fig. 13 - Switching Time Waveforms

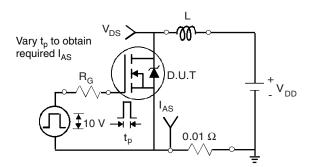


Fig. 14 - Unclamped Inductive Test Circuit

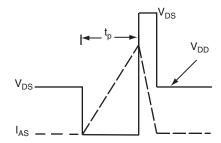


Fig. 15 - Unclamped Inductive Waveforms

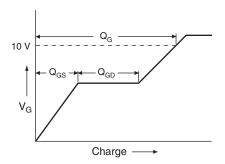


Fig. 16 - Basic Gate Charge Waveform

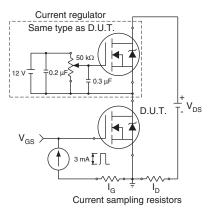
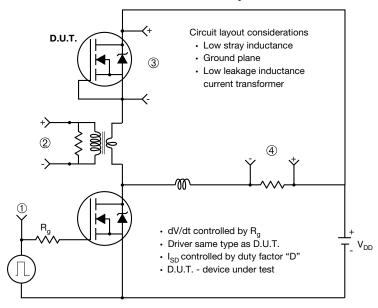


Fig. 17 - Gate Charge Test Circuit



## Peak Diode Recovery dV/dt Test Circuit



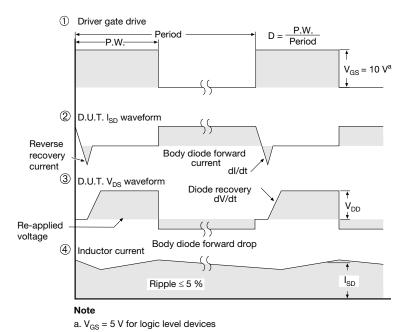


Fig. 18 - For N-Channel

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